

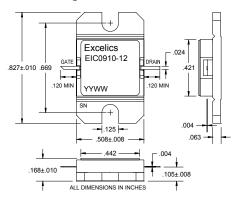
EIC0910-12

UPDATED 03/07/2008

9.50-10.50 GHz 12-Watt Internally Matched Power FET

FEATURES

- 9.50–10.50GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +40.5 dBm Output Power at 1dB Compression
- 7.0 dB Power Gain at 1dB Compression
- 30% Power Added Efficiency
- -46 dBc IM3 at PO = 28.5 dBm SCL
- 100% Tested for DC, RF, and R_{TH}





Caution! ESD sensitive device.

ELECTRICAL CHARACTERISTICS (T_a = 25°C)

SYMBOL	PARAMETERS/TEST CONDITIONS ¹	MIN	TYP	MAX	UNITS
P _{1dB}	Output Power at 1dB Compression $f = 9.50-10.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200Ma$	39.5	40.5		dBm
G _{1dB}	Gain at 1dB Compression $f = 9.50-10.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200\text{mA}$	6.0	7.0		dB
ΔG	Gain Flatness $f = 9.50-10.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200\text{mA}$			±0.6	dB
PAE	Power Added Efficiency at 1dB Compression V_{DS} = 10 V, $I_{DSQ} \approx 3200$ mA $f = 9.50-10.50$ GHz		30		%
Id _{1dB}	Drain Current at 1dB Compression f = 9.50-10.50GHz		3300	4200	mA
IM3	Output 3rd Order Intermodulation Distortion Δf =10MHz 2-Tone Test. Pout=28.5 dBm S.C.L Vds = 10 V, $I_{DSQ} \approx 65\% I_{DSS}$ f = 10.50GHz	-43	-46		dBc
I _{DSS}	Saturated Drain Current V _{DS} = 3 V, V _{GS} = 0 V		6500	9000	mA
V_P	Pinch-off Voltage $V_{DS} = 3 \text{ V}, I_{DS} = 58 \text{ mA}$		-2.5	-4.0	V
R _{TH}	Thermal Resistance ³		2.3	2.6	°C/W

Note: 1. Tested with 50 Ohm gate resistor.

2. S.C.L. = Single Carrier Level.

3. Overall Rth depends on case mounting.

ABSOLUTE MAXIMUM RATING^{1,2}

SYMBOLS	PARAMETERS	ABSOLUTE ¹	CONTINUOUS ²
Vds	Drain-Source Voltage	15	10V
Vgs	Gate-Source Voltage	-5	-4V
lgsf	Forward Gate Current	130mA	43mA
lgsr	Reverse Gate Current	-21mA	-7mA
Pin	Input Power	40.0dBm	@ 3dB Compression
Tch	Channel Temperature	175 °C	175 °C
Tstg	Storage Temperature	-65 to +175 °C	-65 to +175 °C
Pt	Total Power Dissipation	57W	57W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

2. Exceeding any of the above ratings may reduce MTTF below design goals.



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